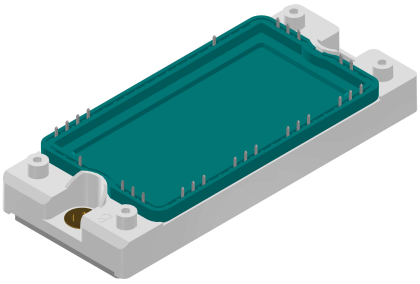
Standard Rectifier Module

3~ Rectifier	Brake Chopper
V_{RRM} = 1600 V	V_{CES} = 1200 V
I_{DAV} = 240 A	I_{C25} = 180 A
I_{FSM} = 1500 A	$V_{CE(sat)}$ = 1.7 V

3~ Rectifier Bridge + Brake Unit

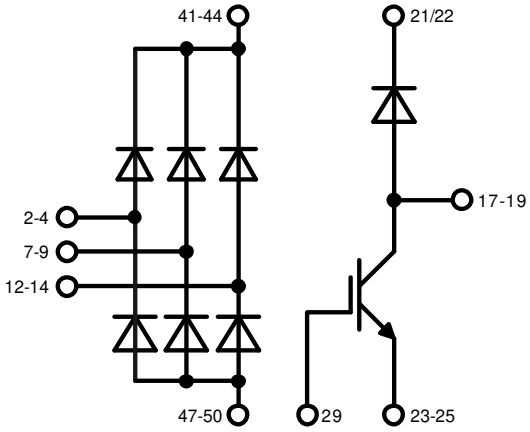
Part number

MDMA240UB1600ED



Backside: isolated

E72873



Features / Advantages:

- Package with DCB ceramic
- Improved temperature and power cycling
- Planar passivated chips
- Very low forward voltage drop
- Very low leakage current
- X2PT - 2nd generation Xtreme light Punch Through
- Rugged X2PT design results in:
  - short circuit rated for 10 µsec.
  - very low gate charge
  - low EMI
  - square RBSOA @ 2x Ic
- Thin wafer technology combined with X2PT design results in a competitive low VCE(sat) and low thermal resistance

Applications:

- 3~ Rectifier with brake unit for drive inverters

Package: E2-Pack

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Height: 17 mm
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling

Disclaimer Notice

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Rectifier				Ratings			
Symbol	**Definition**	**Conditions**		**min.**	**typ.**	**max.**	**Unit**
V_{RSM}	*max. non-repetitive reverse blocking voltage*		T_{VJ} = 25°C			1700	V
V_{RRM}	*max. repetitive reverse blocking voltage*		T_{VJ} = 25°C			1600	V
I_R	*reverse current*	V_R = 1600 V	T_{VJ} = 25°C			100	µA
		V_R = 1600 V	T_{VJ} = 150°C			2	mA
V_F	*forward voltage drop*	I_F = 80 A	T_{VJ} = 25°C			1.28	V
		I_F = 240 A				1.92	V
		I_F = 80 A	T_{VJ} = 125°C			1.22	V
		I_F = 240 A				2.02	V
I_{DAV}	*bridge output current*	T_C = 85°C	T_{VJ} = 150°C			240	A
		rectangular d = 120°					
V_{F0}	*threshold voltage* } *for power loss calculation only*		T_{VJ} = 150°C			0.80	V
r_F	*slope resistance*					5.2	mΩ
R_{thJC}	*thermal resistance junction to case*					0.4	K/W
R_{thCH}	*thermal resistance case to heatsink*				0.1		K/W
P_{tot}	*total power dissipation*		T_C = 25°C			312	W
I_{FSM}	*max. forward surge current*	t = 10 ms; (50 Hz), sine	T_{VJ} = 45°C			1.50	kA
		t = 8,3 ms; (60 Hz), sine	V_R = 0 V			1.62	kA
		t = 10 ms; (50 Hz), sine	T_{VJ} = 150°C			1.28	kA
		t = 8,3 ms; (60 Hz), sine	V_R = 0 V			1.38	kA
I^2t	*value for fusing*	t = 10 ms; (50 Hz), sine	T_{VJ} = 45°C			11.3	kA²s
		t = 8,3 ms; (60 Hz), sine	V_R = 0 V			10.9	kA²s
		t = 10 ms; (50 Hz), sine	T_{VJ} = 150°C			8.13	kA²s
		t = 8,3 ms; (60 Hz), sine	V_R = 0 V			7.87	kA²s
C_J	*junction capacitance*	V_R = 400 V; f = 1 MHz	T_{VJ} = 25°C		58		pF

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Brake IGBT + Diode				Ratings			
Symbol	**Definition**	**Conditions**		**min.**	**typ.**	**max.**	**Unit**
V_{CES}	*collector emitter voltage*		T_{VJ} = 25°C			1200	V
V_{GES}	*max. DC gate voltage*					±20	V
V_{GEM}	*max. transient gate emitter voltage*					±30	V
I_{C25}	*collector current*		T_C = 25°C			180	A
I_{C80}			T_C = 80°C			140	A
P_{tot}	*total power dissipation*		T_C = 25°C			500	W
$V_{CE(sat)}$	*collector emitter saturation voltage*	I_C = 100 A; V_{GE} = 15 V	T_{VJ} = 25°C		1.7	2.1	V
			T_{VJ} = 125°C		1.9		V
$V_{GE(th)}$	*gate emitter threshold voltage*	I_C = 4 mA; V_{GE} = V_{CE}	T_{VJ} = 25°C	6	6.8	7.5	V
I_{CES}	*collector emitter leakage current*	V_{CE} = V_{CES}; V_{GE} = 0 V	T_{VJ} = 25°C			0.1	mA
			T_{VJ} = 125°C		0.1		mA
I_{GES}	*gate emitter leakage current*	V_{GE} = ±20 V				500	nA
$Q_{G(on)}$	*total gate charge*	V_{CE} = 600 V; V_{GE} = 15 V; I_C = 100 A			340		nC
$t_{d(on)}$	*turn-on delay time*	inductive load; V_{CE} = 600 V; I_C = 100 A; V_{GE} = ±15 V; R_G = 6.8 Ω	T_{VJ} = 125°C		230		ns
t_r	*current rise time*				70		ns
$t_{d(off)}$	*turn-off delay time*				380		ns
t_f	*current fall time*				230		ns
E_{on}	*turn-on energy per pulse*				12.5		mJ
E_{off}	*turn-off energy per pulse*				11.5		mJ
RBSOA	*reverse bias safe operating area*	V_{GE} = ±15 V; R_G = 6.8 Ω	T_{VJ} = 125°C				
I_{CM}		V_{CEK} = 1200 V				300	A
SCSOA	*short circuit safe operating area*	V_{CEK} = 1200 V					
t_{SC}	*short circuit duration*	V_{CE} = 720 V; V_{GE} = ±15	T_{VJ} = 125°C			10	µs
I_{SC}	*short circuit current*	R_G = 6.8 Ω; non-repetitive			450		A
R_{thJC}	*thermal resistance junction to case*					0.25	K/W
R_{thCH}	*thermal resistance case to heatsink*				0.10		K/W
Brake Diode							
V_{RRM}	*max. repetitive reverse voltage*		T_{VJ} = 25°C			1200	V
I_{F25}	*forward current*		T_C = 25°C			88	A
I_{F80}			T_C = 80°C			59	A
V_F	*forward voltage*	I_F = 60 A	T_{VJ} = 25°C			2.20	V
			T_{VJ} = 125°C		1.95		V
I_R	*reverse current*	V_R = V_{RRM}	T_{VJ} = 25°C			0.1	mA
			T_{VJ} = 125°C			1.2	mA
Q_{rr}	*reverse recovery charge*	V_R = 600 V; $-di_F/dt$ = 900 A/µs; I_F = 60 A; V_{GE} = 0 V	T_{VJ} = 125°C		9.6		µC
I_{RM}	*max. reverse recovery current*				47		A
t_{rr}	*reverse recovery time*				450		ns
E_{rec}	*reverse recovery energy*				3		mJ
R_{thJC}	*thermal resistance junction to case*					0.6	K/W
R_{thCH}	*thermal resistance case to heatsink*				0.1		K/W

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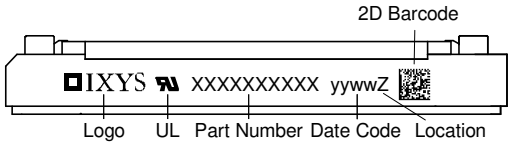
Package E2-Pack				Ratings			
Symbol	**Definition**	**Conditions**		**min.**	**typ.**	**max.**	**Unit**
I_{RMS}	*RMS current*	per terminal				50	A
T_{VJ}	*virtual junction temperature*			-40		150	°C
T_{op}	*operation temperature*			-40		125	°C
T_{stg}	*storage temperature*			-40		125	°C
Weight					176		g
M_D	*mounting torque*			3		6	Nm
$d_{Spp/App}$	*creepage distance on surface | striking distance through air*		*terminal to terminal*	6.0			mm
$d_{Spb/Apb}$			*terminal to backside*	12.0			mm
V_{ISOL}	*isolation voltage*	t = 1 second	50/60 Hz, RMS; I_{ISOL} ≤ 1 mA	3600			V
		t = 1 minute		3000			V



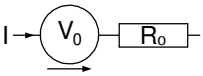
Part description

M = Module
D = Diode
M = Standard Rectifier
A = (up to 1800V)
240 = Current Rating [A]
UB = 3~ Rectifier Bridge + Brake Unit
1600 = Reverse Voltage [V]
ED = E2-Pack

Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	MDMA240UB1600ED	MDMA240UB1600ED	Box	6	520461

Equivalent Circuits for Simulation

** on die level* T_{VJ} = 150°C



Rectifier

$V_{0\,max}$	*threshold voltage*	0.8	V
$R_{0\,max}$	*slope resistance **	2.1	mΩ

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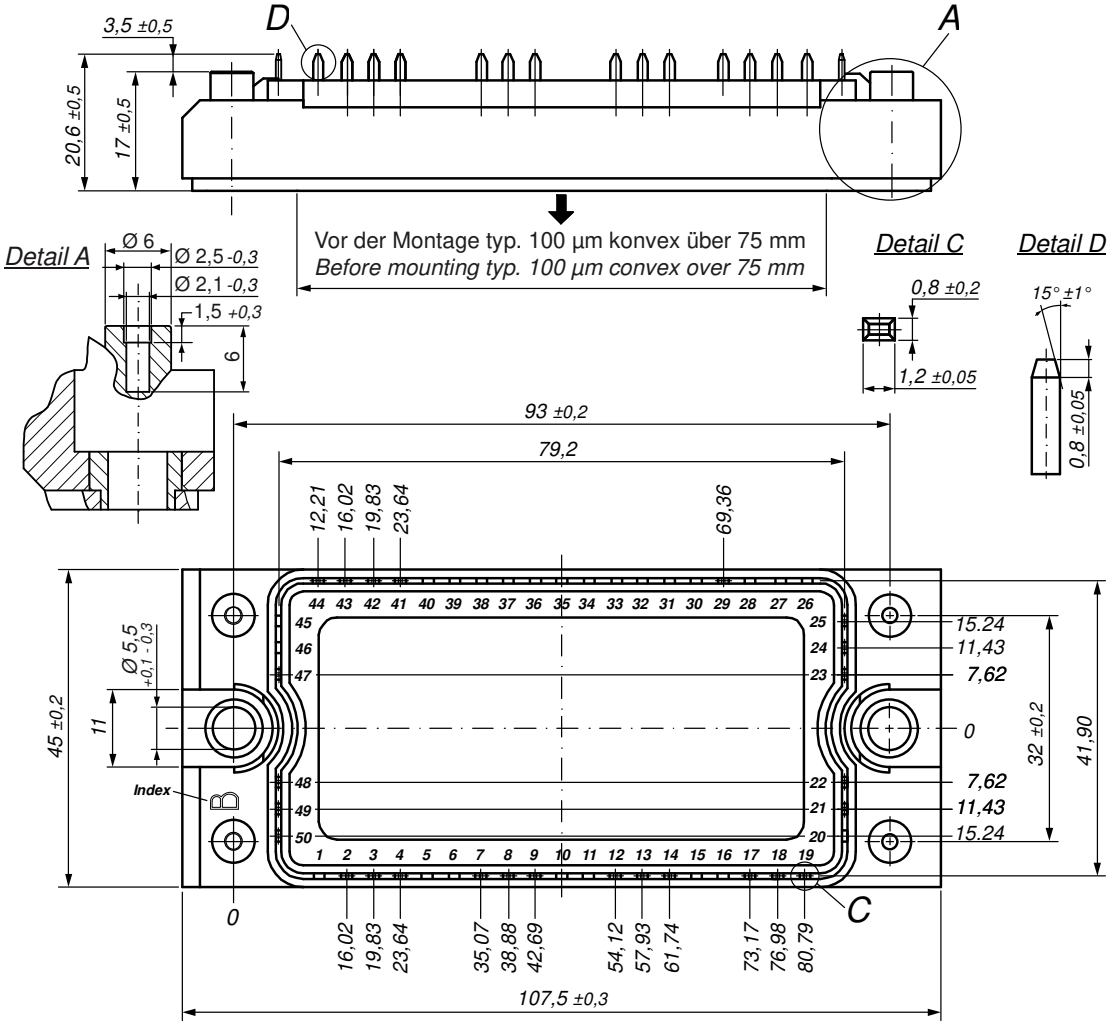
Outlines E2-Pack

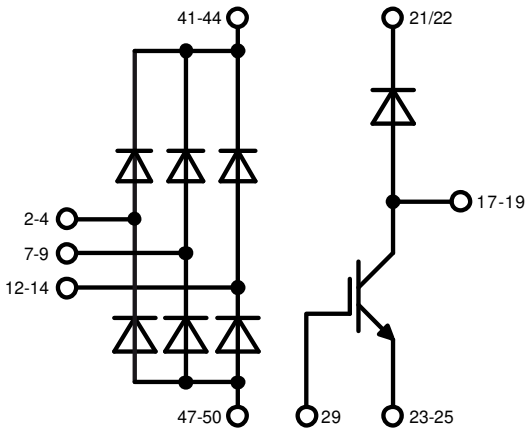


Bemerkung / ***Note:***

- Nichttolerierte Maße nach / *Measure without tolerances according DIN ISO 2768-T1-m*
- PCB-Lochmuster / *PCB hole pattern:* **see pin position**
- Toleranz Pin-Position und PCB-Lochmuster / *Tolerance of pin position and PCB hole pattern:* ⊕ **0.1**
- Montageanleitung / *Mounting instruction:* www.ixys.com **Application note IXAN0024**

***Detail A*:** PCB-Montage / *Mounting on PCB* ⌊

- Empfohlene, selbstschneidende Schraube / *Recommended, self-tapping screw:* **EJOT PT®** (Größe / *size:* **K25**) ⌊
- Max. Schraubenlänge / *Max. screw length:* **PCB-Dicke** / **thickness + 6 mm** *(*max. Lochtiefe / *hole depth)* ⌊
- Empfohlenes Drehmoment / *Recommended mounting torque:* **1.5 Nm**



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Rectifier

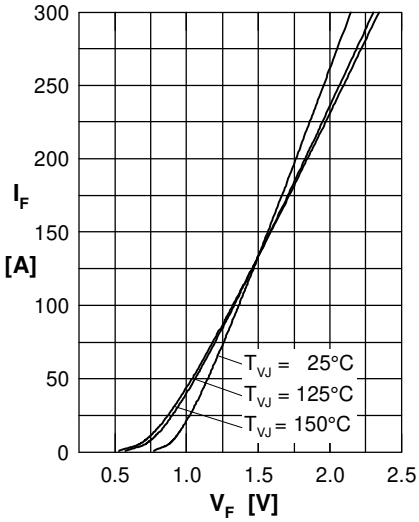

Fig. 1 Forward current versus voltage drop per diode

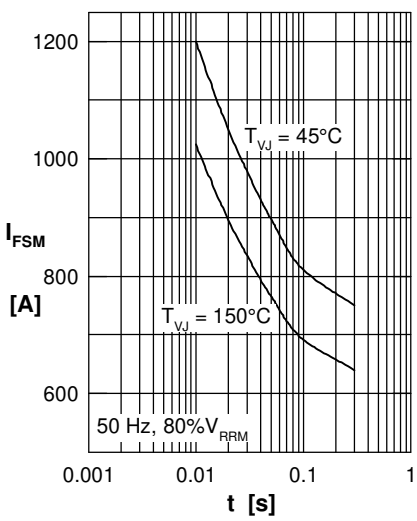

Fig. 2 Surge overload current vs. time per diode

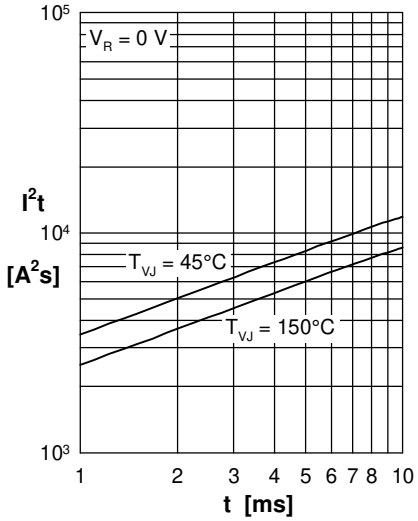

Fig. 3 I^2t versus time per diode

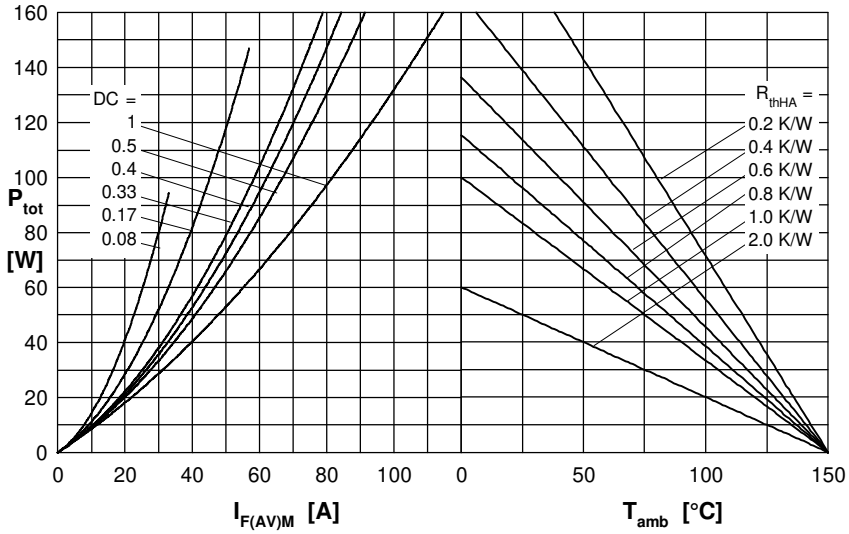

Fig. 4 Power dissipation vs. forward current and ambient temperature per diode

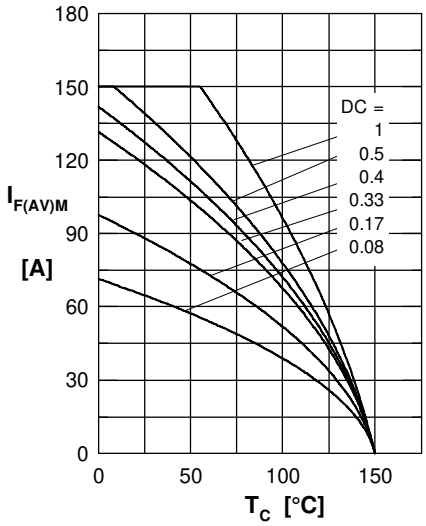

Fig. 5 Max. forward current vs. case temperature per diode

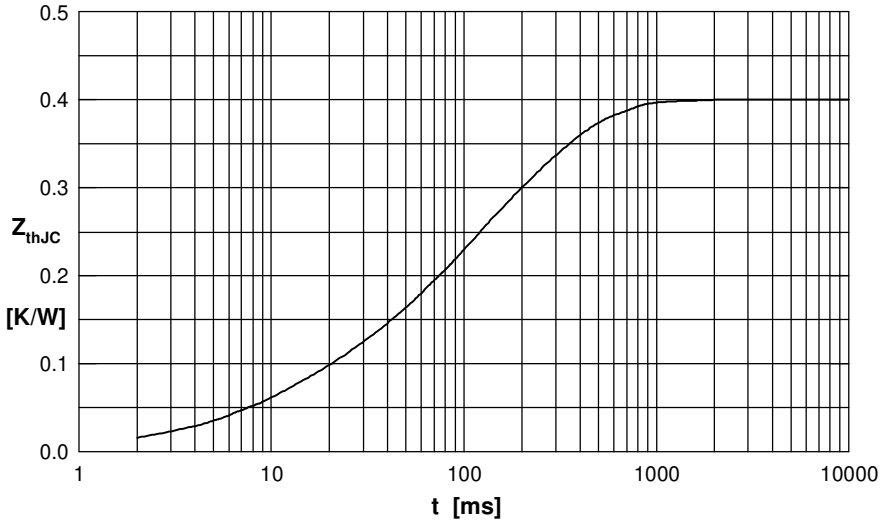

Fig. 6 Transient thermal impedance junction to case vs. time per diode

Constants for Z_{thJC} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.050	0.010
2	0.003	0.007
3	0.090	0.055
4	0.187	0.250
5	0.070	0.120

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Brake IGBT + Diode

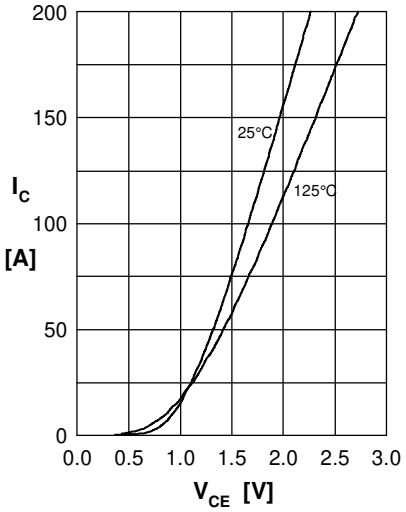

Fig.1 Output characteristics IGBT

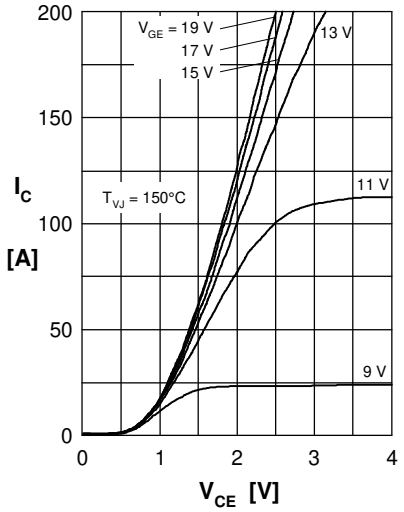

Fig.2 Typ. output characteristics IGBT

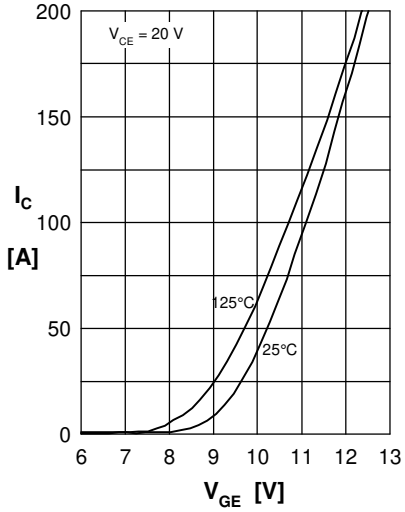

Fig. 3 Typ. transfer charact. IGBT

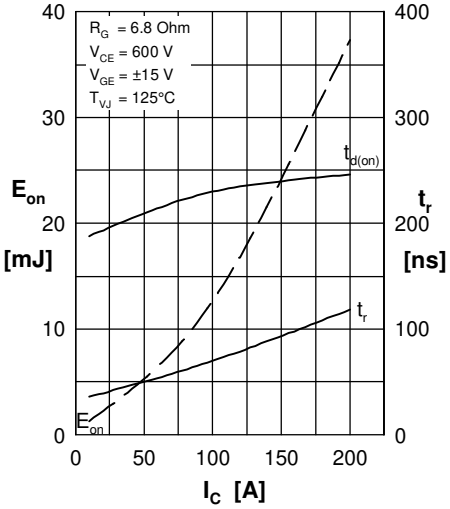

Fig. 4 Typ. turn-on energy & switch. times vs. collector current

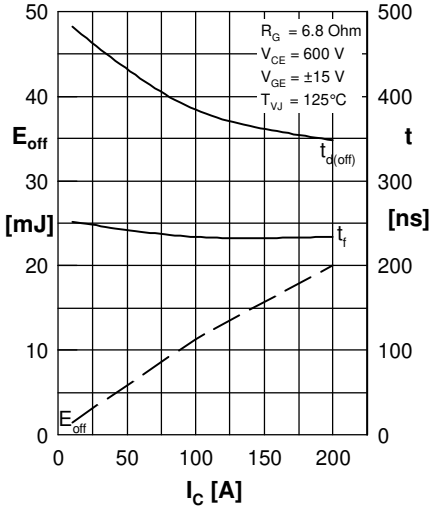

Fig. 5 Typ. turn-off energy & switch. times vs. collector current

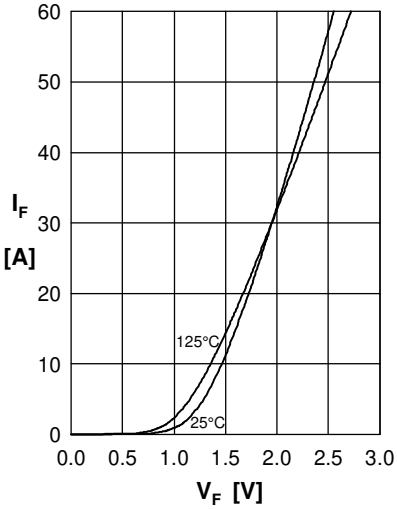

Fig. 6 Typ. forward current versus V_F

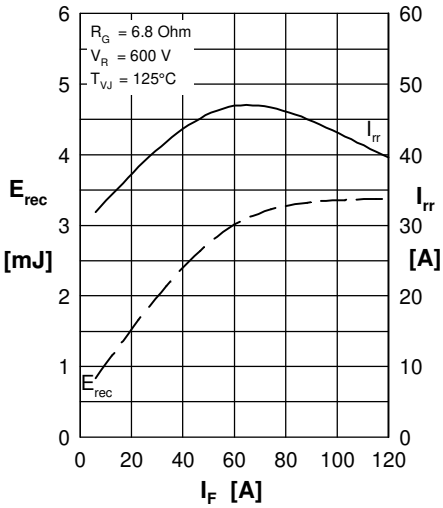

Fig. 7 Typ. reverse recovery characteristics Diode

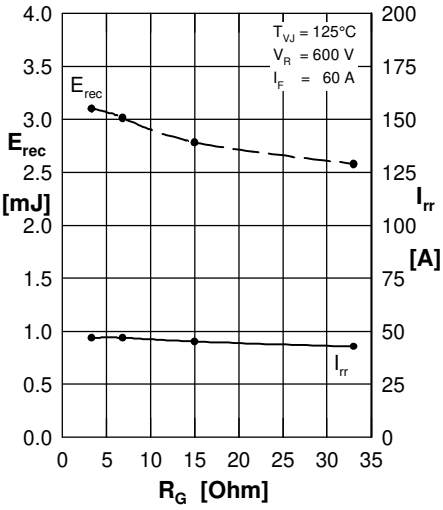

Fig. 8 Typ. reverse recovery characteristics Diode

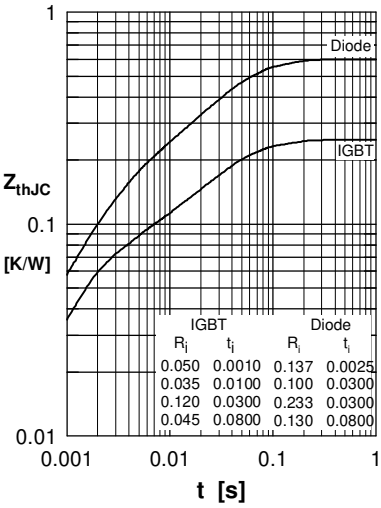

Fig. 9 Transient thermal resistance junction to case

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